

SPECIFICATIONS

Rated Current:1.0AMP

Contact Resistance:20mΩ Max

Withstand Voltage:500V AC/DC

Insulation Resistance:1000MΩ Min

Operation Temperature:-40℃ to +105℃

Contact Material:Brass

Contact Plating:Au or Sn Over Ni

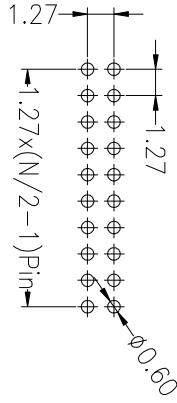
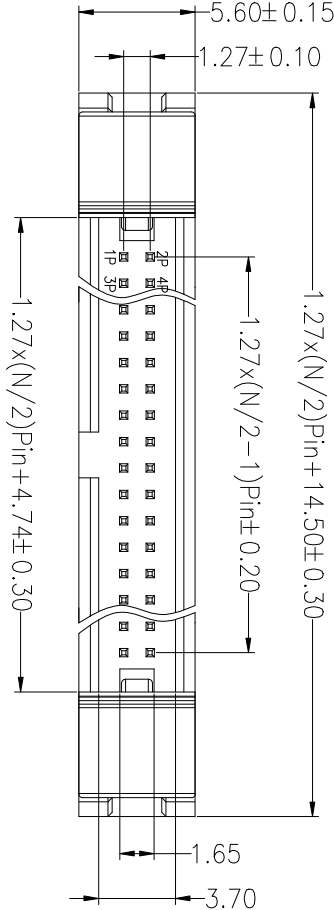
Insulator Material:Polyester(UL94V-0)

Max.Processing Temp:

(PBT)245℃±5℃ For 5~10 Second

(PA6T/LCP/PA9T)260℃±5℃ For 5~10 Second

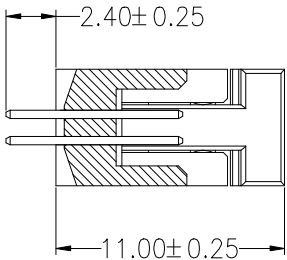
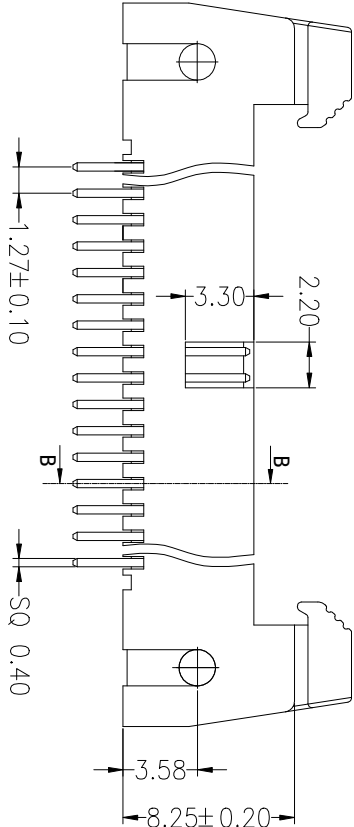
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)



Ordering Information

3330 XX S XX X X S X 0X

No. of Pins 06~80P	Contact Plating G0:Gold Flash G1:10μ" Gold G2:1.5μ" Gold G3:20μ" Gold G4:30μ" Gold G5:50μ" Gold G6:100μ" Gold G7:150μ" Gold G8:300μ" Gold S0:Gold Flash/Tin Sn:Tin	Insulator Material Option A=BK-PBT C=BK-PA6T E=BK-PA9T F=BK-LCP	Color Type B=Black G=Grey	Packing 0=PE Bag A=Trey T=Tube P=Tube+Cap R=Reel+Cap
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SECTION B-B

G	1	2	3	4	5	6	7	8	9
F	Contact Material:Brass Contact Plating:Au or Sn Over Ni Insulator Material:Polyester(UL94V-0) Max.Processing Temp: (PBT)245℃±5℃ For 5~10 Second (PA6T/LCP/PA9T)260℃±5℃ For 5~10 Second								
E									
D									
C									
B									
A	REV	DATE	MODIFICATION	DESCRIPTION	CHANGE	DIM	TOL	APPROVE	
				OPERATION	DRAW				
				X.X	±0.30				
				X.XX	±0.20				
				X.XXX	±0.10				
				Angle	±3°				